To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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RENESAS

MOS FIELD EFFECT POWER TRANSISTOR

2SK1502

Phase-out/Discontinued

SWITCHING
N-CHANNEL POWER MOS FET
INDUSTRIAL USE

DESCRIPTION

The 2SK1502 is N-channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

- Low On-state Resistance
  $R_{DS(on)}$ = 2.0 Ω (V_{GS} = 10 V, I_D = 4 A)
- Low C_{iss} C_{iss} = 1 550 pF TYP.
- Built-in G-S Gate Protection Diode
- High Avalanche Capability Ratings

QUALITY GRADE

Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

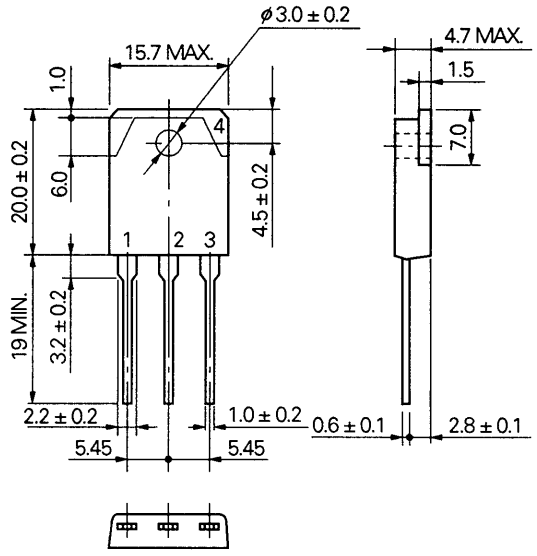
ABSOLUTE MAXIMUM RATINGS (T_a = 25 °C)

Drain to Source Voltage	V_{DSS}	900	V
Gate to Source Voltage	V_{GSS}	±30	V
Drain Current (DC)	$I_{D(DC)}$	±7.0	A
Drain Current (pulse)	$I_{D(pulse)}$*	±14	A
Total Power Dissipation (T_C = 25 °C)	P_T	120	W
Channel Temperature	T_{ch}	150	°C
Storage Temperature	T_{stg}	−55 to +150	°C

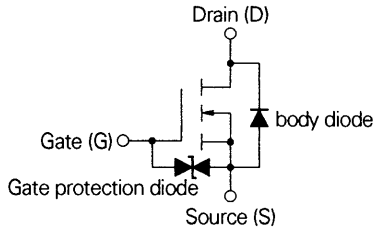
* PW ≦ 10 μs, Duty Cycle ≦ 1 %

PACKAGE DIMENSIONS

in millimeters



1. Gate
2. Drain
3. Source
4. Fin (Drain)



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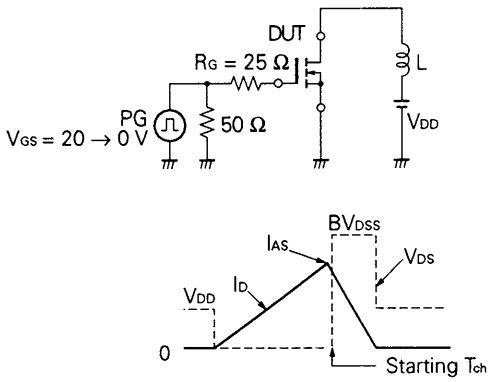
Phase-out/Discontinued

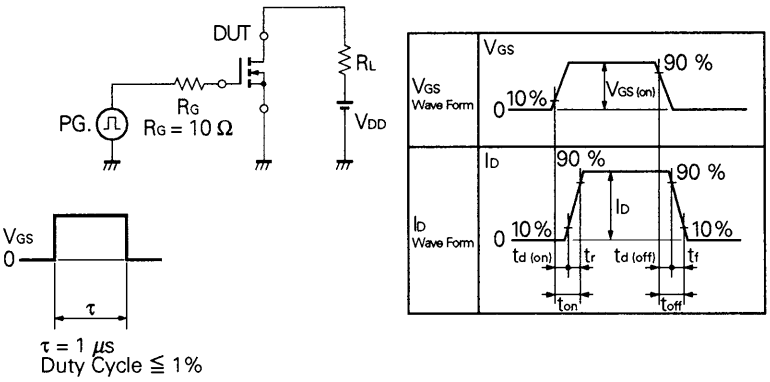
ELECTRICAL CHARACTERISTICS (T_a = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	$R_{DS(on)}$		1.7	2.0	Ω	V_{GS} = 10 V, I_D = 4 A
Gate to Source Cutoff Voltage	$V_{GS(off)}$	2.5		3.5	V	V_{DS} = 10 V, I_D = 1 mA
Forward Transfer Admittance	$\|y_{fs}\|$	2.0	5.8		S	V_{DS} = 20 V, I_D = 4 A
Drain Leakage Current	I_{DSS}			100	μA	V_{DS} = 900 V, V_{GS} = 0
Gate to Source Leakage Current	I_{GSS}			±10	μA	V_{GS} = ±30 V, V_{DS} = 0
Input Capacitance	C_{iss}		1 550		pF	V_{DS} = 10 V V_{GS} = 0 f = 1 MHz
Output Capacitance	C_{oss}		225		pF	
Reverse Transfer Capacitance	C_{rss}		75		pF	
Turn-On Delay Time	$t_{d(on)}$		25		ns	V_{GS} = 10 V V_{DD} = 150 V I_D = 4 A, R_G = 10 Ω R_L = 37.5 Ω
Rise Time	t_r		30		ns	
Turn-Off Delay Time	$t_{d(off)}$		155		ns	
Fall Time	t_f		35		ns	
Total Gate Charge	Q_G		80		nC	V_{GS} = 10 V I_D = 7 A V_{DD} = 450 V
Gate to Source Charge	Q_{GS}		5		nC	
Gate to Drain Charge	Q_{GD}		35		nC	
Diode Forward Voltage	$V_{F(S-D)}$		0.9		V	I_F = 7 A, V_{GS} = 0
Reverse Recovery Time	t_{rr}		620		ns	I_F = 7 A, V_{GS} = 0 di/dt = 50 A/μs
Reverse Recovery Charge	Q_{rr}		4.2		μC	
Single Avalanche Current	I_{AS}	7.0			A	V_{DD} = 150 V, L = 100 μH R_G = 25 Ω, V_{GS} = 20 V → 0 Unclamped Starting T_{ch} = 25 °C
Channel to Case Thermal Resistance	$R_{th(ch-c)}$			1.04	°C/W	Channel to Case

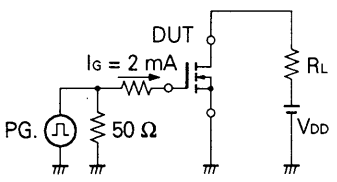
Test Circuit 1: Avalanche Capability



Test Circuit 2: Switching Time

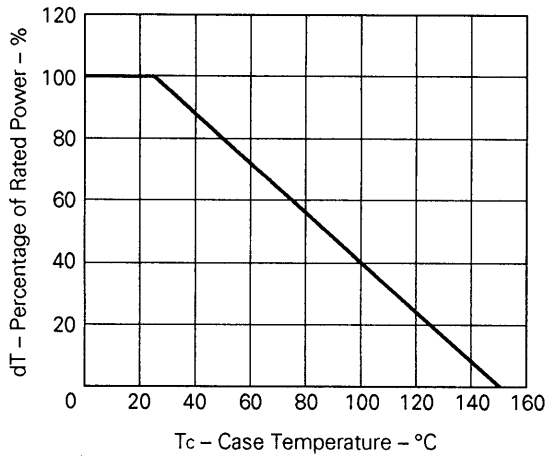


Test Circuit 3: Gate Charge

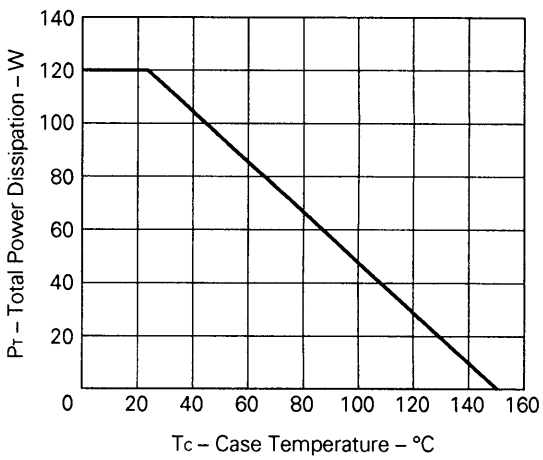


TYPICAL CHARACTERISTICS (T_a = 25 °C)

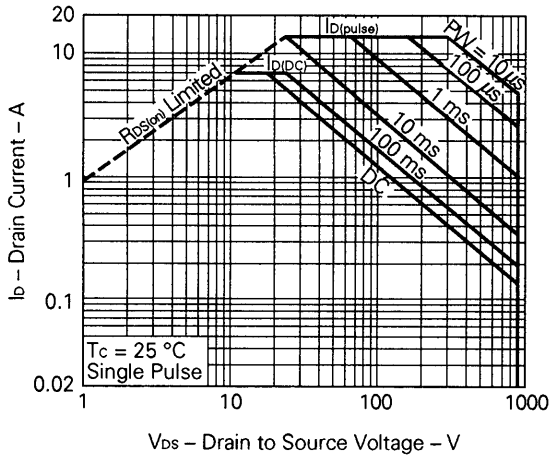
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



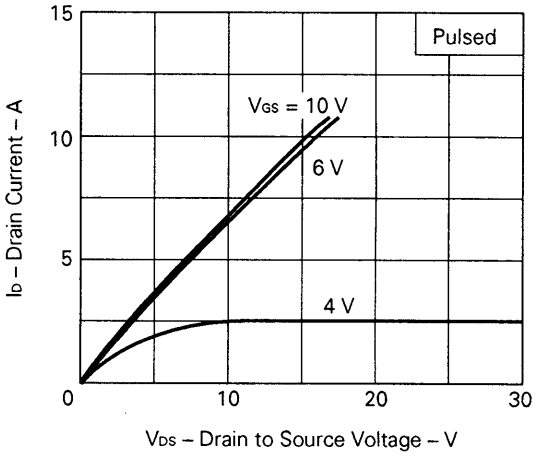
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



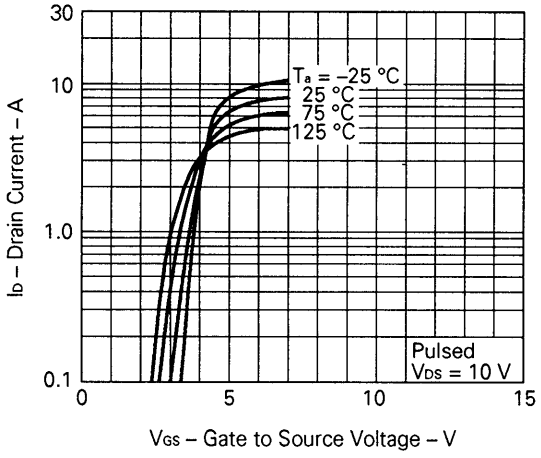
FORWARD BIAS SAFE OPERATING AREA



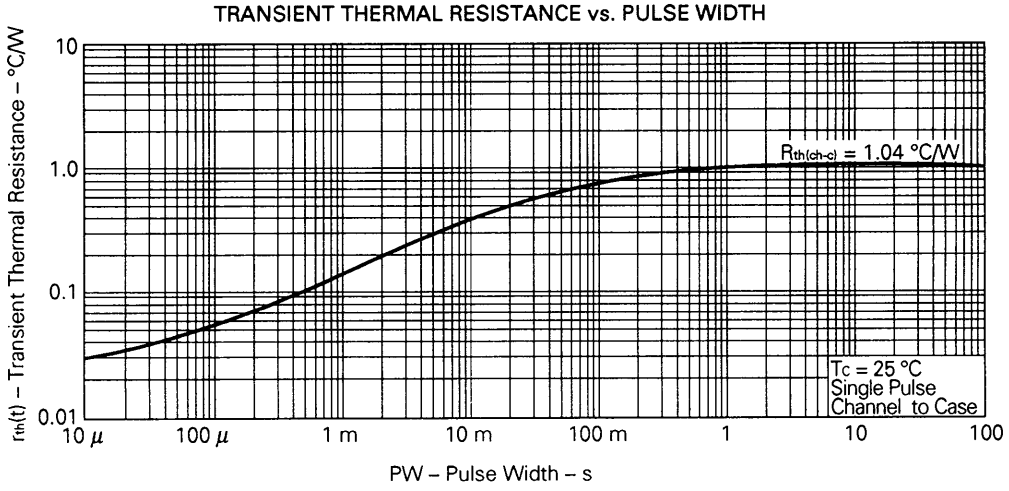
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



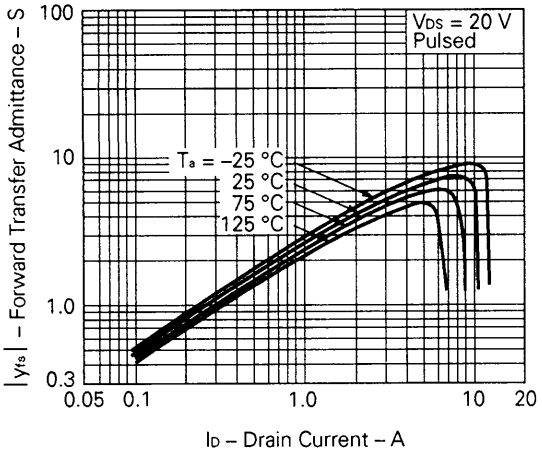
TRANSFER CHARACTERISTICS



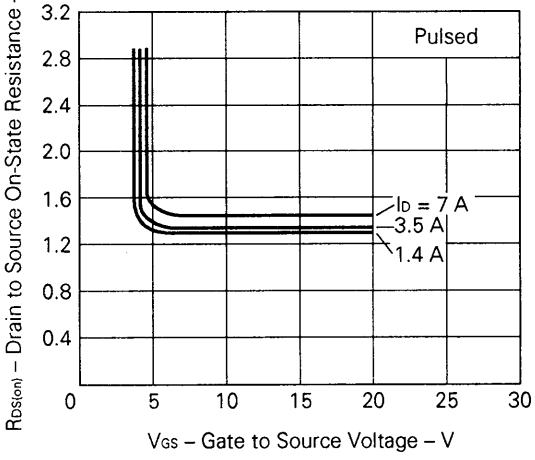
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



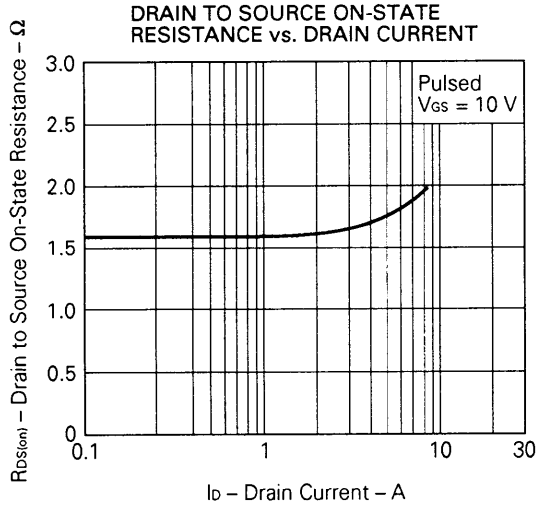
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



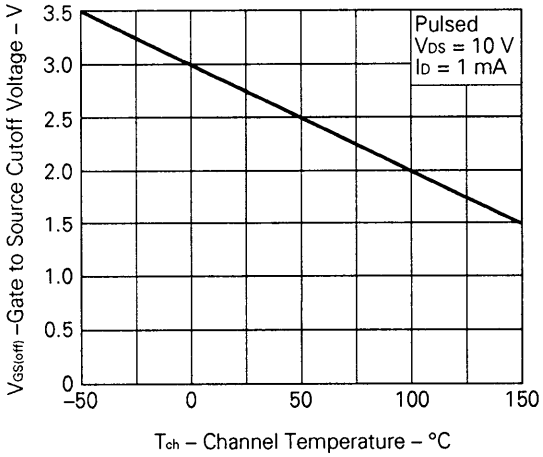
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



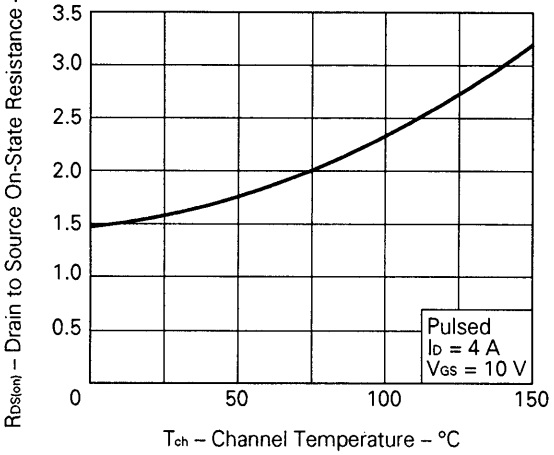
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



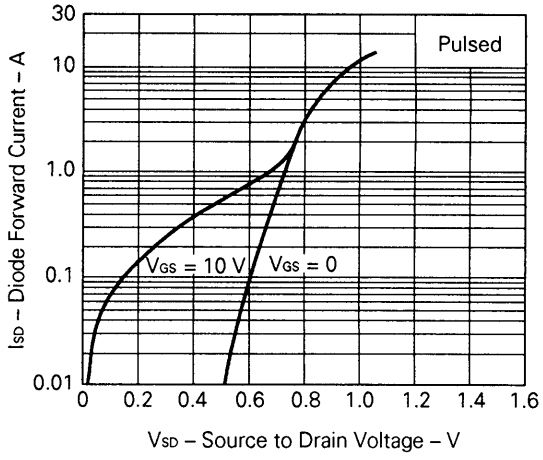
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE



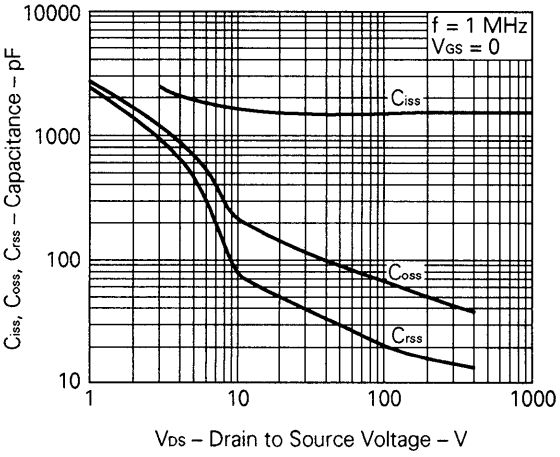
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



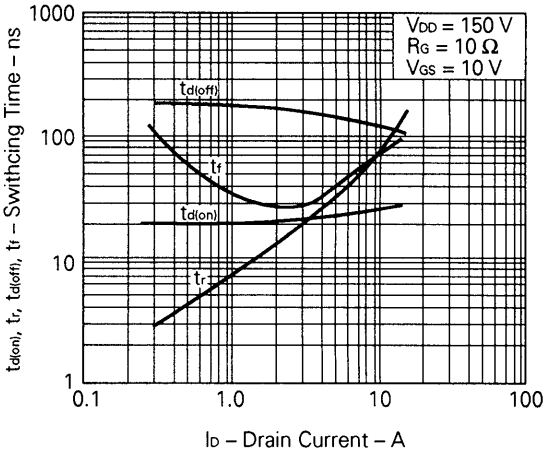
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



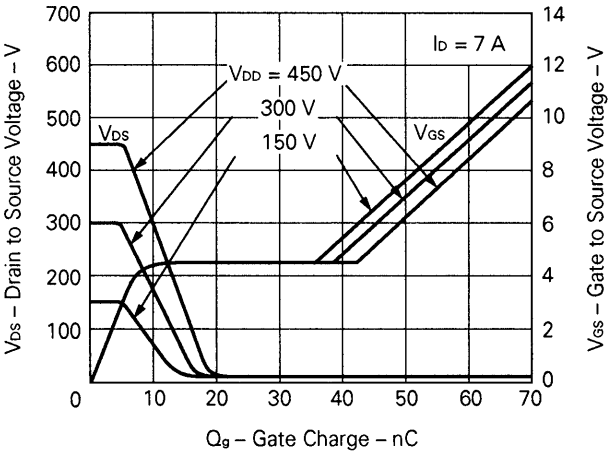
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



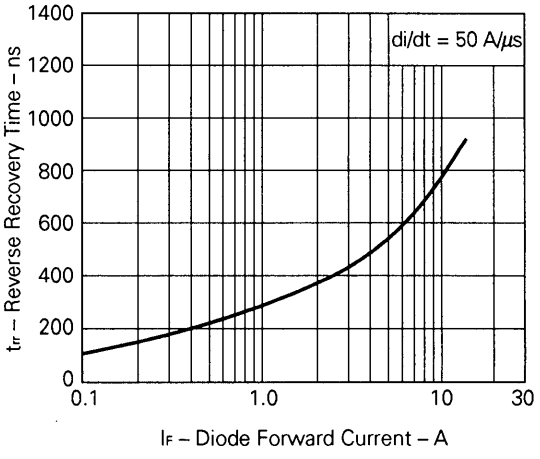
SWITCHING CHARACTERISTICS



DYNAMIC INPUT CHARACTERISTICS



REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



Reference

Application note name	No.
Safe operating area of Power MOS FET.	TEA-1034
Application circuit using Power MOS FET.	TEA-1035
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207

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